

# **FDR858P Datasheet**



DiGi Electronics Part Number

Manufacturer Product Number

Description

Manufacturer

**Detailed Description** 

FDR858P-DG

onsemi

FDR858P

MOSFET P-CH 30V 8A SUPERSOT8

P-Channel 30 V 8A (Ta) 1.8W (Ta) Surface Mount Su perSOT™-8

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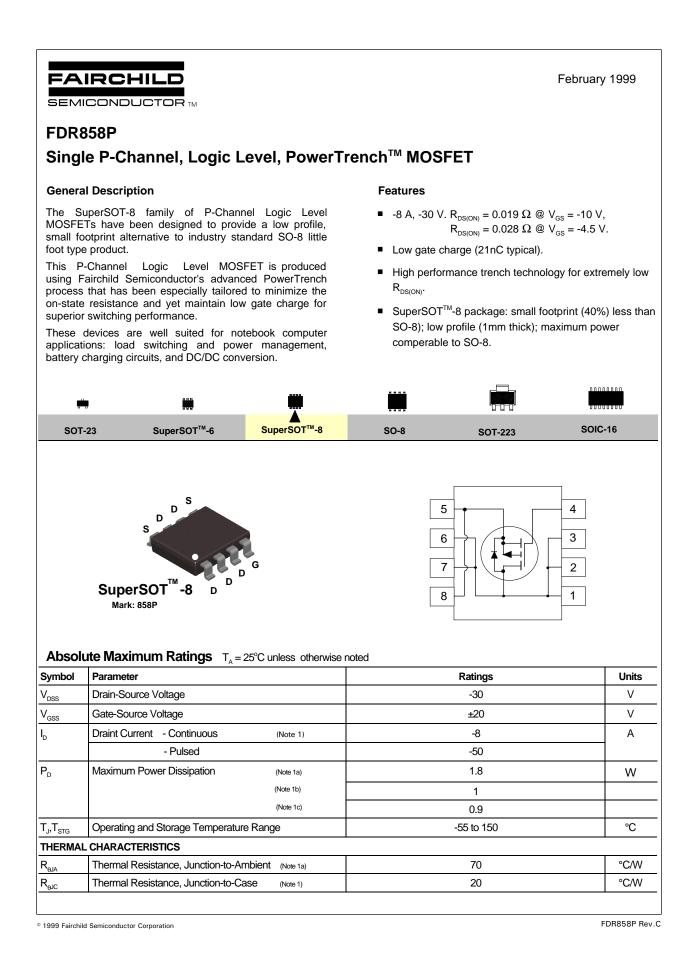


# Purchase and inquiry

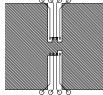
Manufacturer Product Number:	Manufacturer:
FDR858P	onsemi
Series:	Product Status:
	Obsolete
FET Type:	Technology:
P-Channel	MOSFET (Metal Oxide)
Drain to Source Voltage (Vdss):	Current - Continuous Drain (Id) @ 25°C:
30 V	8A (Ta)
Drive Voltage (Max Rds On, Min Rds On):	Rds On (Max) @ ld, Vgs:
4.5V, 10V	19mOhm @ 8A, 10V
Vgs(th) (Max) @ ld:	Gate Charge (Qg) (Max) @ Vgs:
3V @ 250μA	30 nC @ 5 V
Vgs (Max):	Input Capacitance (Ciss) (Max) @ Vds:
±20V	2010 pF @ 15 V
FET Feature:	Power Dissipation (Max):
-	1.8W (Ta)
Operating Temperature:	Mounting Type:
-55°C ~ 150°C (TJ)	Surface Mount
Supplier Device Package:	Package / Case:
SuperSOT™-8	8-LSOP (0.130", 3.30mm Width)
Base Product Number:	
FDR85	

# **Environmental & Export classification**

Moisture Sensitivity Level (MSL):	REACH Status:
1 (Unlimited)	REACH Unaffected
ECCN:	HTSUS:
EAR99	8541.29.0095



Symbol	Parameter	Conditions		Min	Тур	Max	Units
OFF CHAR	ACTERISTICS						
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS} = 0 V, I_{D} = -250 \mu A$		-30			V
$\Delta BV_{DSS} / \Delta T_{J}$	Breakdown Voltage Temp. Coefficient	$I_{\rm D}$ = -50 µA, Referenced t	o 25 ℃		-22		mV /⁰C
DSS	Zero Gate Voltage Drain Current	$V_{DS} = -24 V, V_{GS} = 0 V$				-1	μA
			T <sub>J</sub> = 55°C			-10	μA
GSS	Gate - Body Leakage Current	$V_{GS} = 20 \text{ V}, V_{DS} = 0 \text{ V}$				100	nA
GSS	Gate - Body Leakage, Reverse	$V_{GS} = -20 \text{ V}, V_{DS} = 0 \text{ V}$				-100	nA
	CTERISTICS (Note 2)						
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$		-1	-1.7	-3	V
$\Delta V_{GS(th)} / \Delta T_J$	Gate Threshold Voltage Temp.Coefficient	$I_{\rm D}$ = -50 µA, Referenced to	o 25 °C		4		mV /°C
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance	$V_{GS} = -10 \text{ V}, \ \text{I}_{D} = -8 \text{ A}$			0.0155	0.019	Ω
			T <sub>J</sub> = 125°C		0.021	0.03	
		$V_{GS} = -4.5 \text{ V}, \ \text{I}_{D} = -6.3 \text{ A}$			0.022	0.028	
D(ON)	On-State Drain Current	$V_{GS} = -10 \text{ V}, \ V_{DS} = -5 \text{ V}$		-50			Α
FS	Forward Transconductance	$V_{DS} = -10 \text{ V}, \ \text{I}_{D} = -3.2 \text{ A}$			25		S
DYNAMIC C	HARACTERISTICS						
C <sub>iss</sub>	Input Capacitance	$V_{DS} = -15 V, V_{GS} = 0 V,$ f = 1.0 MHz			2010		pF
C <sub>oss</sub>	Output Capacitance	f = 1.0 MHZ			590		pF
C <sub>rss</sub>	Reverse Transfer Capacitance				260		pF
SWITCHING	CHARACTERISTICS (Note 2)						
D(on)	Turn - On Delay Time	$V_{DD} = -15 \text{ V}, \ \text{I}_{D} = -1 \text{ A},$			12	22	ns
r	Turn - On Rise Time	$V_{GS}$ = -10V, $R_{GEN}$ = 6 $\Omega$			15	27	ns
D(off)	Turn - Off Delay Time				100	140	ns
f	Turn - Off Fall Time				55	80	ns
2 <sub>g</sub>	Total Gate Charge	$V_{DS} = -15 \text{ V}, \ \text{I}_{D} = -8 \text{ A},$			21	30	nC
ସ <sub>ୁs</sub>	Gate-Source Charge	$V_{GS} = 5 V$			6		nC
ସ <sub>ୁଗ</sub>	Gate-Drain Charge				8		nC
DRAIN-SO	URCE DIODE CHARACTERISTICS AND MA	XIMUM RATINGS					
s	Maximum Continuous Drain-Source Diode Forward Current				-0.67	Α	
√ <sub>sd</sub>	Drain-Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}, I_{S} = -0.67 \text{ A}$ (N	lote 2)		-0.7	-1.2	V



a. 70°C/W on a 1 in<sup>2</sup> pad of 2oz copper.



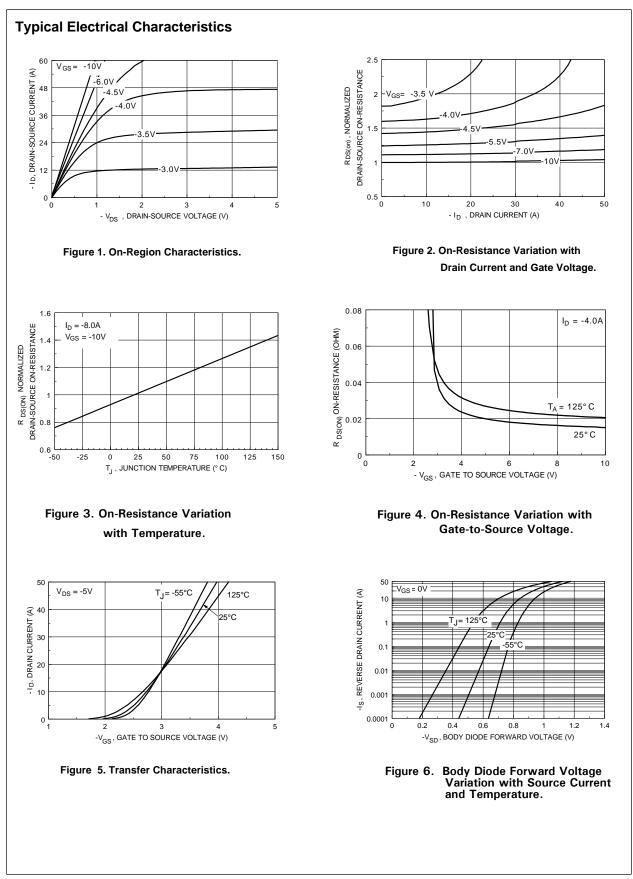
b. 125<sup>o</sup>C/W on a 0.026 in<sup>2</sup> of pad of 2oz copper.

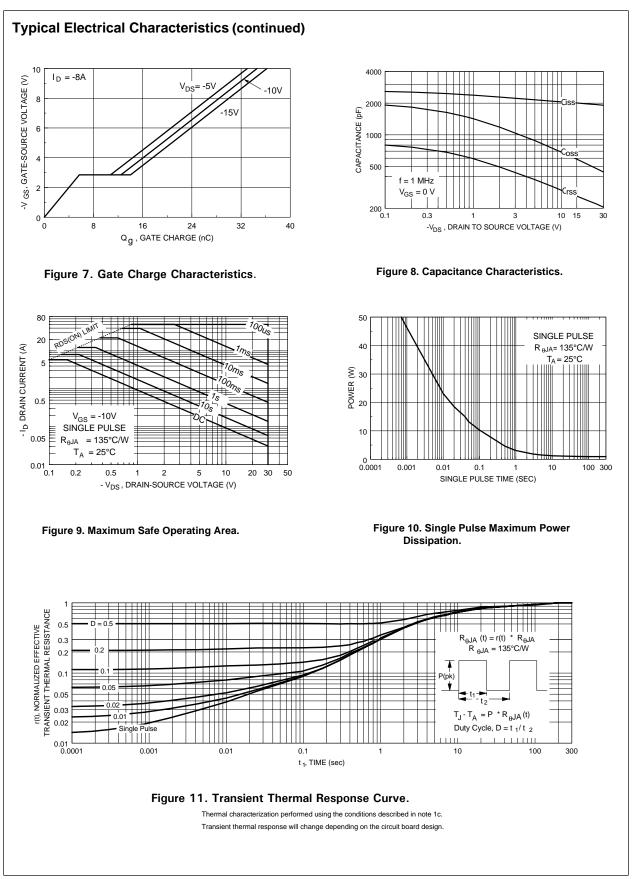
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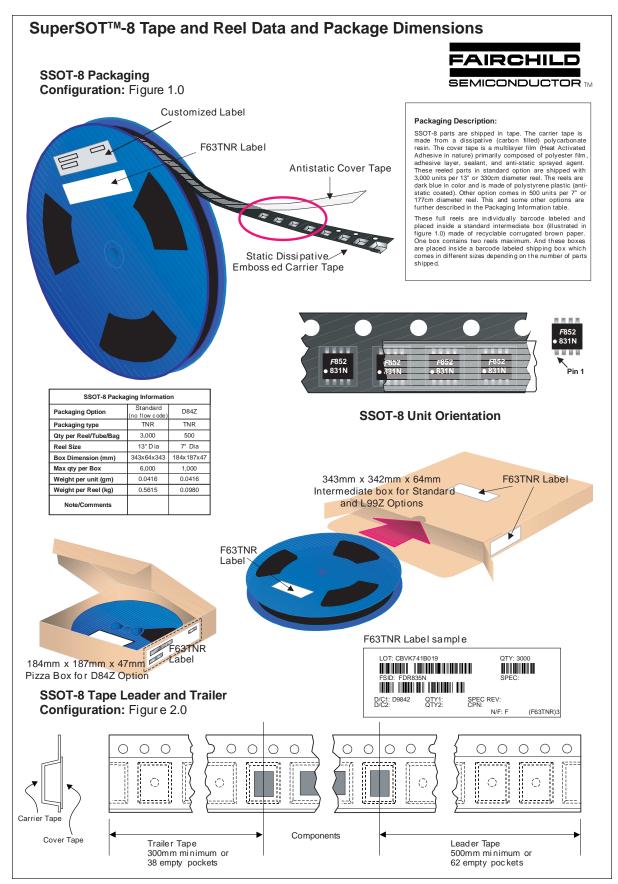
c. 135<sup>o</sup>C/W on a 0.005 in<sup>2</sup> of pad of 2oz copper.

Scale 1 : 1 on letter size paper

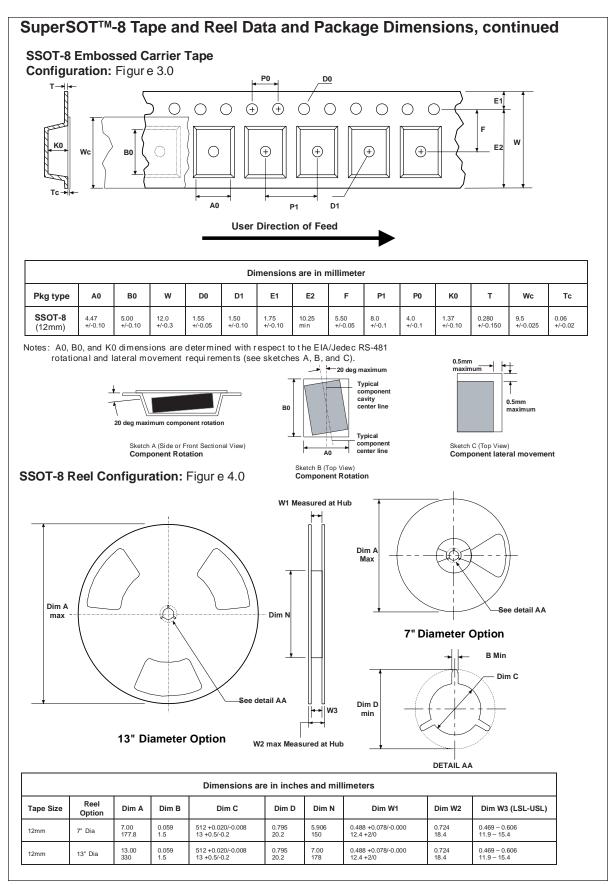
2. Pulse Test: Pulse Width  $\leq$  300µs, Duty Cycle  $\leq$  2.0%.

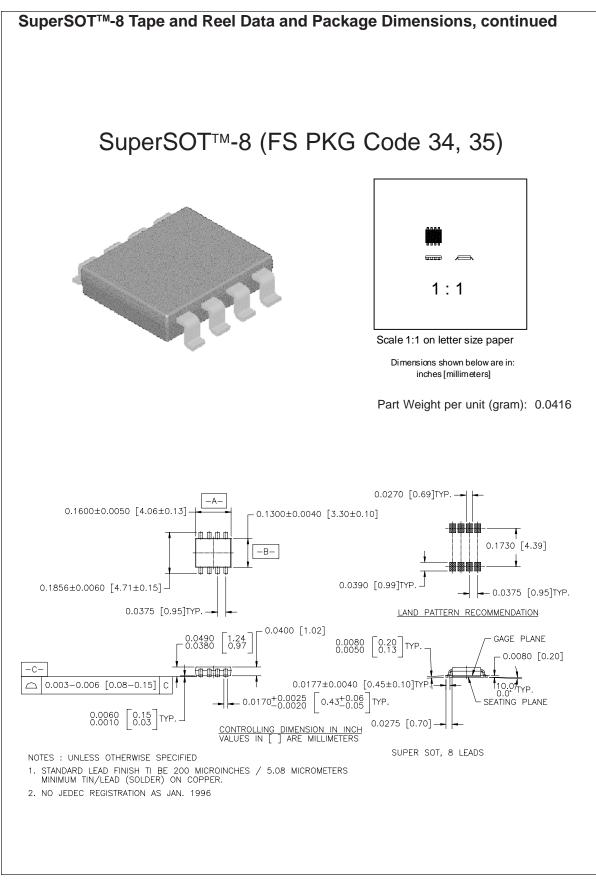






August 1999, Rev. C





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Product Status	Definition
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